

Converter - Brake - Inverter Module

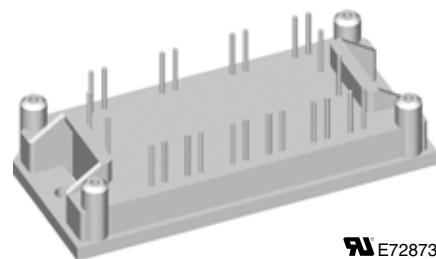
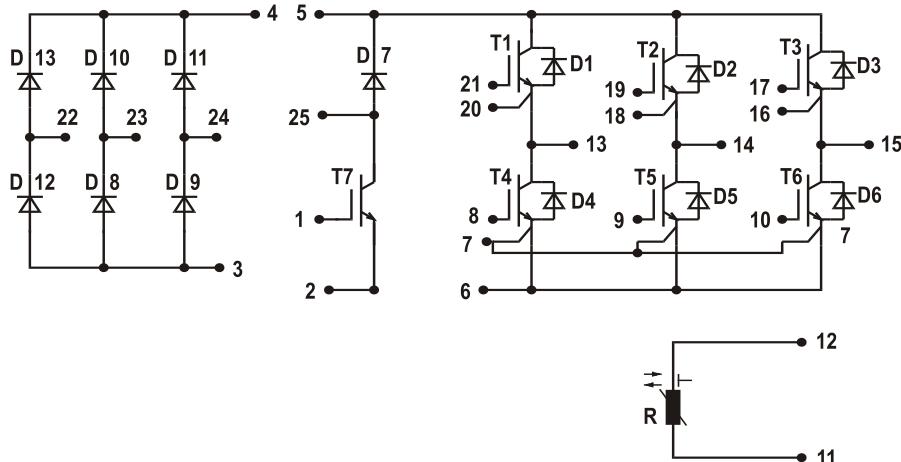
XPT IGBT

Preliminary data

Three Phase Rectifier	Brake Chopper	Three Phase Inverter
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 1200 \text{ V}$	$V_{CES} = 1200 \text{ V}$
$I_{DAVM25} = 100 \text{ A}$	$I_{C25} = 17 \text{ A}$	$I_{C25} = 17 \text{ A}$
$I_{FSM} = 320 \text{ A}$	$V_{CE(sat)} = 1.8 \text{ V}$	$V_{CE(sat)} = 1.8 \text{ V}$

Part name (Marking on product)

MIXA10WB1200TML



E72873

Pin configuration see outlines.

Features:

- High level of integration - only one power semiconductor module required for the whole drive
- Rugged XPT design (Xtreme light Punch Through) results in:
 - short circuit rated for 10 μsec .
 - very low gate charge
 - square RBSOA @ 3x I_c
 - low EMI
- Thin wafer technology combined with the XPT design results in a competitive low $V_{CE(sat)}$
- Temperature sense included
- SONIC™ diode
 - fast and soft reverse recovery
 - low operating forward voltage

Application:

- AC motor drives
- Pumps, Fans
- Washing machines
- Air-conditioning system
- Inverter and power supplies

Package:

- DCB based "E1-Pack"
- Assembly height is 17 mm
- Insulated base plate
- UL registered E72873

Output Inverter T1 - T6

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{CES}	collector emitter voltage	$T_{VJ} = 25^\circ C$		1200		V
V_{GES}	max. DC gate voltage	continuous		± 20		V
V_{GEM}	max. transient collector gate voltage	transient		± 30		V
I_{C25}	collector current	$T_C = 25^\circ C$	17		A	
I_{C80}		$T_C = 80^\circ C$	12		A	
P_{tot}	total power dissipation	$T_C = 25^\circ C$	63		W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 9 A; V_{GE} = 15 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	1.8 2.1	2.1	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.3 mA; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ C$	5.5	6.0	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	0.02 0.2	0.1	mA mA
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20 V$		500		nA
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 V; V_{GE} = 15 V; I_C = 10 A$		27		nC
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 125^\circ C$ $V_{CE} = 600 V; I_C = 10 A$ $V_{GE} = \pm 15 V; R_G = 100 \Omega$	70			ns
t_r	current rise time		40			ns
$t_{d(off)}$	turn-off delay time		250			ns
t_f	current fall time		100			ns
E_{on}	turn-on energy per pulse		1.1			mJ
E_{off}	turn-off energy per pulse		1.1			mJ
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15 V; R_G = 100 \Omega; V_{CEK} = 1200 V$ $T_{VJ} = 125^\circ C$		30		A
I_{sc} (SCSOA)	short circuit safe operating area	$V_{CE} = 900 V; V_{GE} = \pm 15 V;$ $R_G = 100 \Omega; t_p = 10 \mu s$; non-repetitive	$T_{VJ} = 125^\circ C$	40		A
R_{thJC}	thermal resistance junction to case	(per IGBT)			2.0	K/W
R_{thCH}	thermal resistance case to heatsink			0.7		K/W

Output Inverter D1 - D6

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 25^\circ C$		1200		V
I_{F25}	forward current	$T_C = 25^\circ C$	19		A	
I_{F80}		$T_C = 80^\circ C$	13		A	
V_F	forward voltage	$I_F = 10 A; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	1.95 1.85	2.2	V
Q_{rr}	reverse recovery charge	$T_{VJ} = 125^\circ C$ $V_R = 600 V$ $di_F/dt = -250 A/\mu s$ $I_F = 10 A; V_{GE} = 0 V$	tbd			μC
I_{RM}	max. reverse recovery current		tbd			A
t_{rr}	reverse recovery time		tbd			ns
E_{rec}	reverse recovery energy		tbd			mJ
R_{thJC}	thermal resistance junction to case	(per diode)		2.4		K/W
R_{thCH}	thermal resistance case to heatsink		0.8			K/W

Brake T7

Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{CES}	collector emitter voltage	$T_{VJ} = 25^\circ C$		1200		V
V_{GES}	max. DC gate voltage	continuous		± 20		V
V_{GEM}	max. transient collector gate voltage	transient		± 30		V
I_{C25}	collector current	$T_C = 25^\circ C$	17		A	
I_{C80}		$T_C = 80^\circ C$	12		A	
P_{tot}	total power dissipation	$T_C = 25^\circ C$	63		W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 9 A; V_{GE} = 15 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	1.8 2.1	2.1	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.3 mA; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ C$	5.5	6.0	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	0.01 0.1	0.1	mA mA
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20 V$		500		nA
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 V; V_{GE} = 15 V; I_C = 10 A$		27		nC
$t_{d(on)}$	turn-on delay time	<div style="border-left: 1px solid black; padding-left: 10px;">inductive load $V_{CE} = 600 V; I_C = 10 A$ $V_{GE} = \pm 15 V; R_G = 100 \Omega$</div>	70			ns
t_r	current rise time		40			ns
$t_{d(off)}$	turn-off delay time		250			ns
t_f	current fall time		100			ns
E_{on}	turn-on energy per pulse		1.1			mJ
E_{off}	turn-off energy per pulse		1.1			mJ
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15 V; R_G = 100 \Omega; V_{CEK} = 1200 V$ $T_{VJ} = 125^\circ C$		30		A
I_{sc} (SCSOA)	short circuit safe operating area	$V_{CE} = 900 V; V_{GE} = \pm 15 V;$ $R_G = 100 \Omega; t_p = 10 \mu s$; non-repetitive	$T_{VJ} = 125^\circ C$	40		A
R_{thJC} R_{thCH}	thermal resistance junction to case thermal resistance case to heatsink	(per IGBT)		0.7	2.0 K/W K/W	

Brake Chopper D7

Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 150^\circ C$		1200		V
I_{F25}	forward current	$T_C = 25^\circ C$		19		A
I_{F80}		$T_C = 80^\circ C$		13		A
V_F	forward voltage	$I_F = 10 A; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	1.95 1.85	2.2	V V
I_R	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	0.01 0.1	0.1	mA mA
Q_{rr} I_{RM} t_{rr} E_{rec}	reverse recovery charge max. reverse recovery current reverse recovery time reverse recovery energy	$V_R = 600 V$ $di_F/dt = tbd A/\mu s$ $I_F = 10 A; V_{GE} = 0 V$	$T_{VJ} = 125^\circ C$	tbd tbd tbd tbd		μC A ns mJ
R_{thJC} R_{thCH}	thermal resistance junction to case thermal resistance case to heatsink	(per diode)		0.8	2.4 K/W K/W	

Input Rectifier Bridge D8 - D11

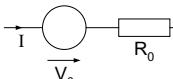
Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	<i>max. repetitive reverse voltage</i>		T _{VJ} = 25°C		1600	V
I_{FAV}	<i>average forward current</i>	sine 180°	T _C = 80°C		24	A
I_{DAVM}	<i>max. average DC output current</i>	rect.; d = 1/3	T _C = 80°C		69	A
I_{FSM}	<i>max. forward surge current</i>	t = 10 ms; sine 50 Hz	T _{VJ} = 25°C T _{VJ} = 125°C		270 240	A A
I²t	<i>I²t value for fusing</i>	t = 10 ms; sine 50 Hz	T _{VJ} = 25°C T _{VJ} = 125°C		360 290	A ² s A ² s
P_{tot}	<i>total power dissipation</i>		T _C = 25°C		70	W
V_F	<i>forward voltage</i>	I _F = 30 A	T _{VJ} = 25°C T _{VJ} = 125°C	1.27 1.24	1.7	V
I_R	<i>reverse current</i>	V _R = V _{RRM}	T _{VJ} = 25°C T _{VJ} = 125°C	0.02 0.2	mA mA	
R_{thJC}	<i>thermal resistance junction to case</i>	(per diode)			1.8	K/W
R_{thCH}	<i>thermal resistance case to heatsink</i>	(per diode)			0.6	K/W

Temperature Sensor NTC

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
R₂₅	<i>resistance</i>		T _C = 25°C	4.45	4.7	kΩ
B_{25/50}					3510	K

Module

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
T_{VJ}	<i>operating temperature</i>		-40		125	°C
T_{VJM}	<i>max. virtual junction temperature</i>				150	°C
T_{stg}	<i>storage temperature</i>		-40		125	°C
V_{ISOL}	<i>isolation voltage</i>	I _{ISOL} ≤ 1 mA; 50/60 Hz			2500	V~
CTI	<i>comparative tracking index</i>				-	
M_d	<i>mounting torque</i>	(M4)	2.0		2.2	Nm
d_S	<i>creep distance on surface</i>		12.7			mm
d_A	<i>strike distance through air</i>		7.6			mm
Weight				40		g

Equivalent Circuits for Simulation**Ratings**

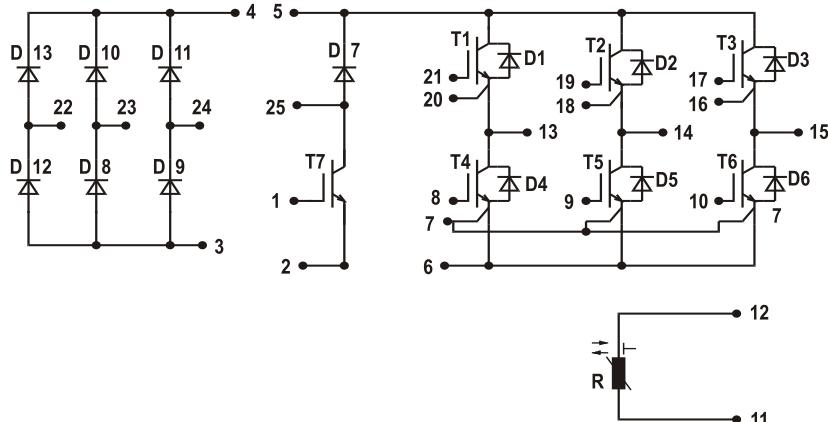
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V₀	<i>rectifier diode</i>	D8 - D13	T _{VJ} = 150°C		0.86	V
R₀					12.3	mΩ
V₀	<i>IGBT</i>	T1 - T6	T _{VJ} = 150°C		1.1	V
R₀					153	mΩ
V₀	<i>free wheeling diode</i>	D1 - D6	T _{VJ} = 150°C		1.09	V
R₀					91	mΩ
V₀	<i>IGBT</i>	T7	T _{VJ} = 150°C		1.1	V
R₀					153	mΩ
V₀	<i>free wheeling diode</i>	D7	T _{VJ} = 150°C		1.09	V
R₀					91	mΩ

IXYS reserves the right to change limits, test conditions and dimensions.

T_C = 25°C unless otherwise stated

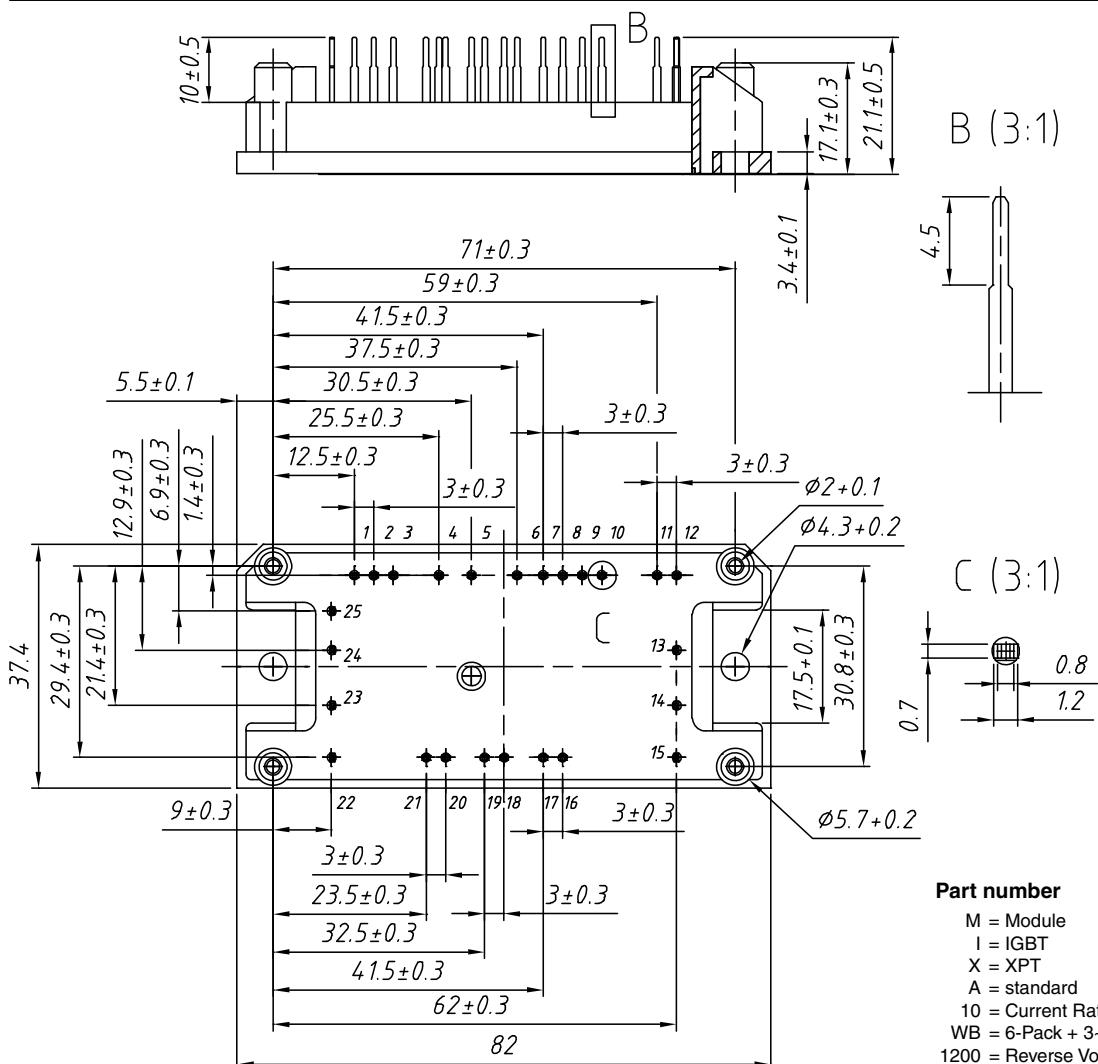
20110916c

Circuit Diagram



Outline Drawing

Dimensions in mm (1 mm = 0.0394")



Part number

M = Module
 I = IGBT
 X = XPT
 A = standard
 10 = Current Rating [A]
 WB = 6-Pack + 3~ Rectifier Bridge & Brake Unit
 1200 = Reverse Voltage [V]
 T = NTC
 ML = E1-Pack

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MIXA 10 WB 1200 TML	MIXA10WB1200TML	Box	10	509367

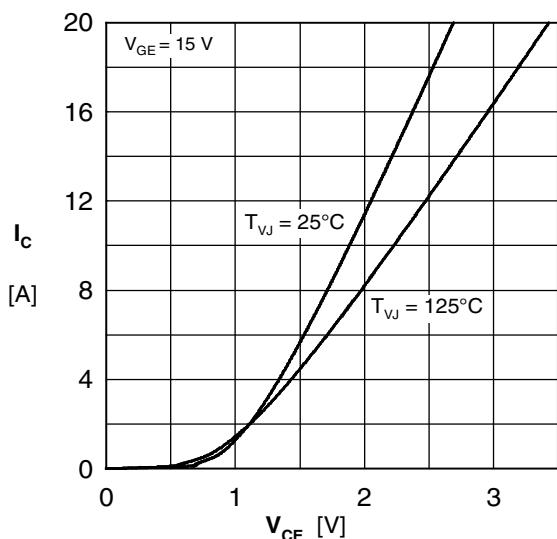


Fig. 1 Typ. output characteristics

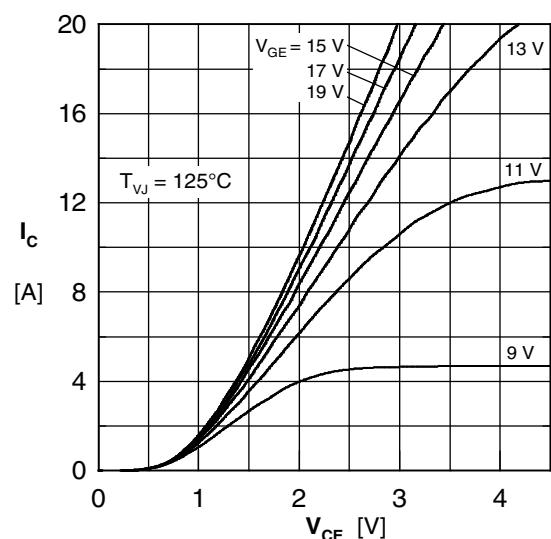


Fig. 2 Typ. output characteristics

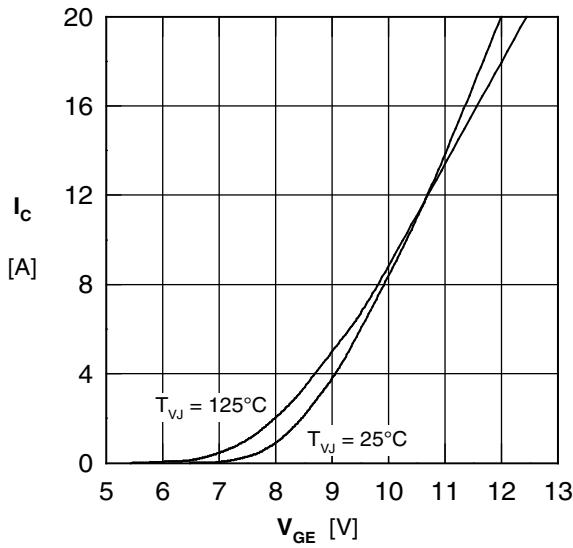


Fig. 3 Typ. tranfer characteristics

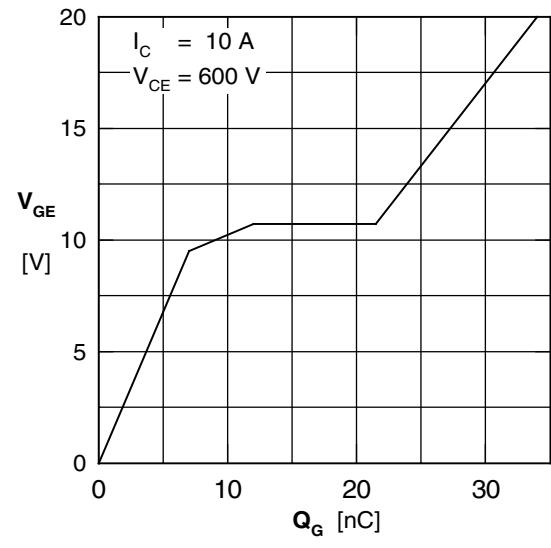


Fig. 4 Typ. turn-on gate charge

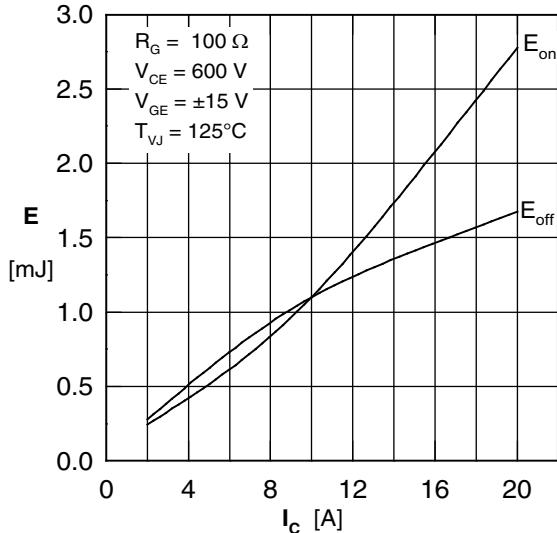


Fig. 5 Typ. switching energy vs. collector current

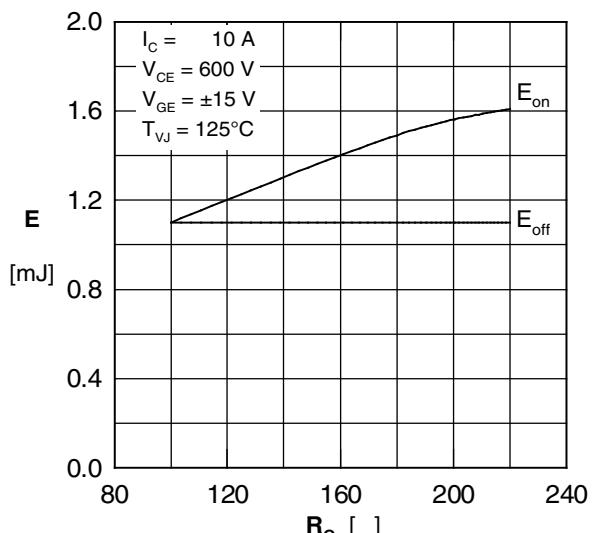


Fig. 6 Typ. switching energy vs. gate resistance

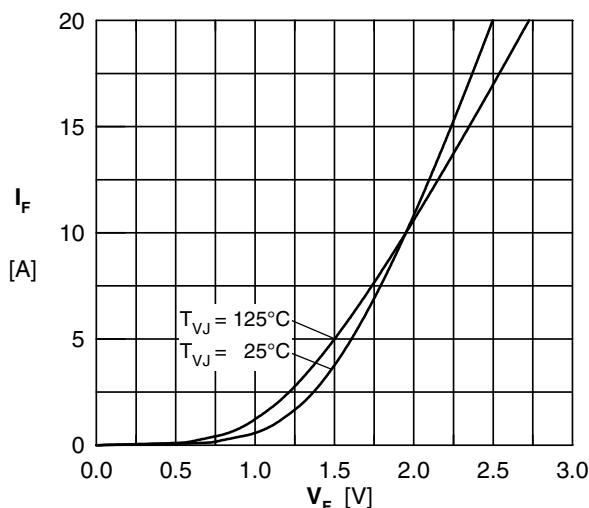


Fig. 7 Typ. forward characteristics

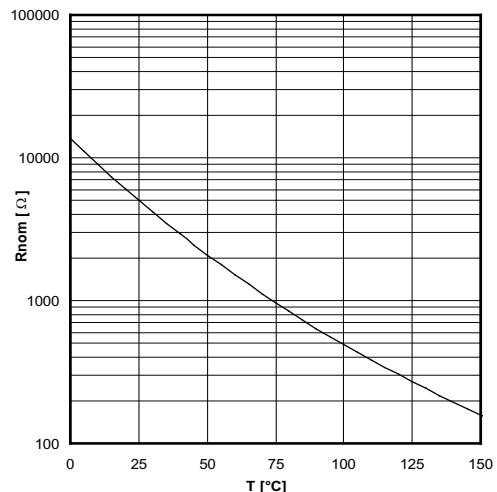


Fig. 8 Typ. thermistor resistance vs. temperature